

Motivation

- **Demand:** Military reconnaissance, remote space/field meters/monitors, implantable biomedical devices, and portable/mobile consumer electronics.
 - *Portable (small and compact)*
 - *Lightweight*
 - *Long-Lasting (long life)*
 - *Self-Powered*
 - *Self-Sustaining*

Power Management

- > Bias circuits
- > References
- > Regulators
- > Watch-dog functions
- > Protection Circuits
- > ...

Front-End Interface

- > Sensors
- > Filters
- > Amplifiers
- > A/D Converters
- > ...

Back-End Interface

- > D/A Converters
- > Filters
- > Amplifiers
- > Power Drivers
- > ...

Desirable Solution: Total Integration
 And for portability and low cost,
Total Chip Integration

- *System-on-Chip (SoC) – integrate into silicon*
- *System-in-Package (SiP) – integrate into the chip package*
- *System-on-Package (SoP) – annex to the chip package*



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SoC/SiP/SoP Solutions

- **Integration of Chip-Compatible Components:**
 - Energy Sources: Thermoelectric, RF-Derived, Solar, & Vibration-Based (electrostatic) Generators (MEMS)
 - Energy Storage Devices: *(order: increasing energy)*
 - Inductors – MEMS, Planar Aluminum- and Copper-Based, & CMOS Active Multipliers
 - Capacitors – MEMS, CMOS Poly-Poly-Active, & CMOS Active Multipliers
 - Batteries – Thin-Film Lithium-Ion Technology
 - Micro-scale, Chip-Packaged Fuel Cells
 - Application Circuits:
 - Transceivers, Monitors, Sensors, Converters, Controllers, Micro-Processors (CPUs), and so on.
 - CMOS Power Management Circuits: *(interface)*
 - Mode managers, regulators, chargers, references, monitors, bias currents & voltages, etc.



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Electronic System

- **Power Management Functions:**
 - * Interface
 - * Charge
 - * Supply/Transfer
 - * Load-Share
 - * Regulate
 - * Power-Mode
 - * Supervise
 - * ...

→ Power Management Circuits = "Brain" and "Housekeeper"

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Energy Sources/Storage

- Key = Maximize Operation Life (i.e., battery life or runtime)

Ragone Plot

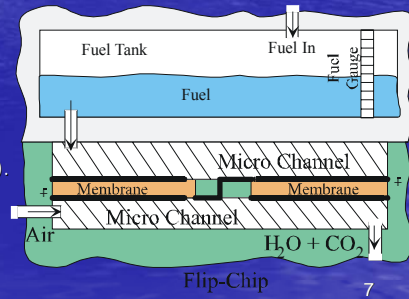
- * Fuel Cells: Slow, highest energy at light Loads
- * Li-Ion: Faster, highest energy during burst-peak loads
- * Capacitor: Fastest, highest energy during high peak transient (high di/dt) loads
- * Inductor: Cumbersome & slow but able to transfer energy in the form of current

→ Mode-hop from device to device to operate @ maximum energy (stay on flat traces) & prolong operating life.

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Energy Sources/Storage - Fuel Cell

- Fuel Cell (FC): Electrochemical energy conversion device
 Fuel (e.g., hydrogen) + Oxidant (e.g., oxygen) → Water + Electricity (e.g., current)
- Categories:
 - Alkaline FC (AFC)
 - Molten Carbonate FC (MCFC)
 - Proton-Exchange Membrane FC (PEMFC)
 - Phosphoric Acid FC (PAFC)
 - Solid-Oxide FC (SOFC)
 - Direct Methanol FC (DMFC)...
- DMFC is a variant of PEMFC:
 - * Extracts **hydrogen from liquid methanol** directly, **without** the need of a **bulky fuel reformer** (necessary in other FC to transform hydrocarbon fuels into hydrogen).
 - Therefore,
 - best suited for miniaturization**
 - (40% η at 50-130°C)



Energy Sources/Storage - Fuel Cell

- DMFC:
 - * Issues:
 - Methanol crossover: Fuel **leakage**/loss across membrane
 - * High temperature, diluted methanol, and exotic electrolytes help.
 - Relatively low current ratings (i.e., **low power**)
 - * More concentrated methanol and ultra-capacitor technologies help
 - High over-potentials: **Slow** electrolyte kinetics (slow response times - low BWs)
 - * Active catalysts help
 - * Constant fuel-flow control helps

Energy Sources/Storage

- Operation Life (i.e., battery life or runtime):

$$\text{Life [h]} = \text{Capacity [Ah]} \div I_{\text{Load_Weighted_Total}} [\text{A}] \alpha 1 \div (I_{\text{Load}} \cdot \text{Probability_Density_Function})$$

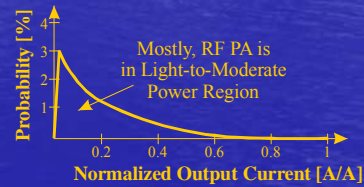
→ For portable applications, *PDF* is **highest** at **moderately light loads** (e.g., idle 80% of the time)

→ **Battery Life** = function of highest

$$I_{\text{Load}} \cdot \text{PDF} \sim \text{moderate light loads}$$

→ **Fuel Cell** has the **most energy** in this region

THUS, allocate volume & resources in chip accordingly

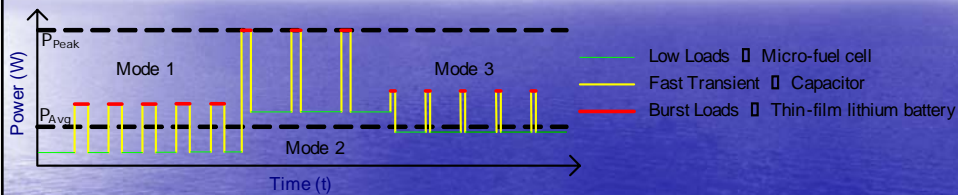


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Power Management

- Transferring Energy to the Load:

Sample Load



- * Load mode hops – off, sleep, idle, receive, transmit, high performance, etc.
- * FC supplies steady-state load - P_{avg} - (charges Li-Ion battery when $P_{\text{Load}} < P_{\text{avg}}$)
- * Li-Ion supplies burst power (FC is slow)
- * Capacitor supplies high di/dt loads (Li-Ion is not fast enough)
- * Inductor help transfer FC/Li-Ion Energy to Capacitor

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Power Management

- **Power System:**
 - * Analog = Noise Sensitive
 DSP ≠ Noise Sensitive
 → Dirty/Clean Supplies
 - * FC supplies DC &
 Li-Ion supplies Peak Bursts
 - * FC also charges Li-Ion
 - * Scavenger charges Li-Ion
 - * FC/Li-Ion charge Ls
 - * Ls supply power to load
 & charge Cs
 - * Cs supply transient loads

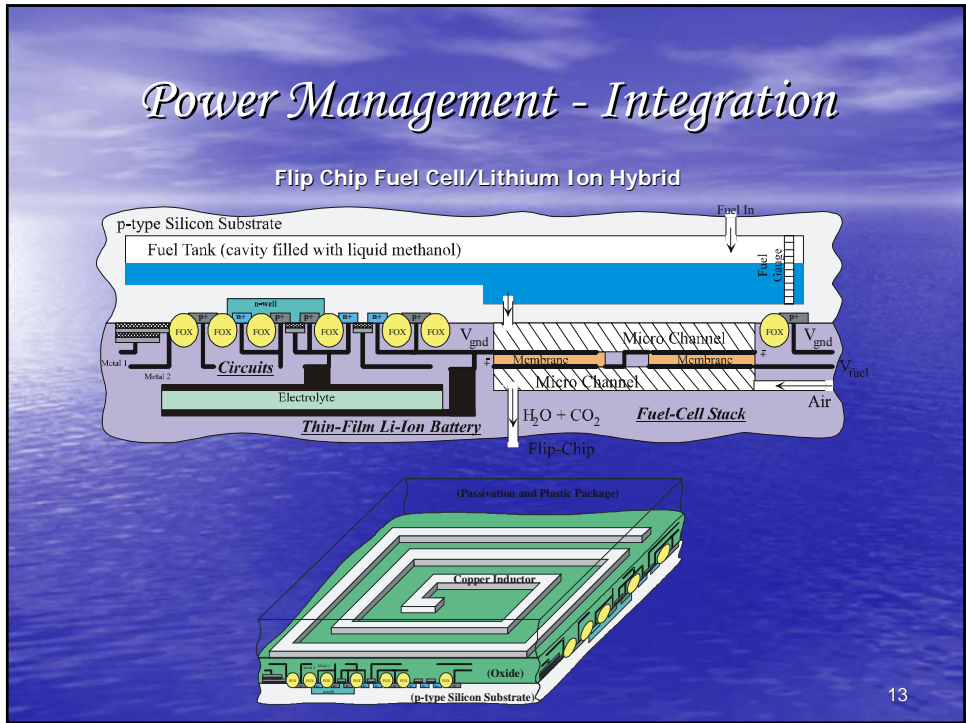
- * Power Efficient Circuits
- * Integrated Ls & Cs
 → MEMS & Multipliers
- * FC/Scav.-Compatible Circuits

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Power Management - Integration

- **Components:**
 - * MEMS Thermoelectric/Vibration Generators
 - * Planar Copper Inductors
 - * FC Stack
 - * Thin-Film Li-Ion Battery
 - * CMOS Inductor/Capacitor Multipliers
 - * CMOS Switching/Linear Regulators/References
 - * System Mode Manager

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- ### Power Management - Challenges
- **Package Integration:**
 - * Fuel Cells
 - * Energy Scavengers
 - * Planer Cu Inductors
 - * Thin-Film Li-Ion
 - * Power MEMS Inductors
 - * Bulk Capacitors
 - * Re-Fueling (unnecessary for disposable applications)
 - * Testability
 - **Power Management:**
 - * *Multiple-Charger-to-Single-Battery System*
 - * *Multiple-Source-to-Single-Output Supply*
 - * Accurate/Fast System Health Monitors
 - * Emergency Battery Handoff
 - **CMOS/BiCMOS Supply Circuits:**
 - * *Fuel Cell Compatible Boost Regulator*
 - * *Fast Capacitor Multipliers*
 - * Efficient, Low-Voltage Power Switches
 - * *Efficient Inductor Multipliers*
 - * *Scavenger-Compatible Intermittent Trickle Boost Charger*
 - * *Fuel Cell Compatible Boost Charger*
 - * Safe Mode-Hop Manager and PM Brain
 - * ...
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The Future...

- The Road: *Design Bridges* → *SiP/SoP/SoC*
*Product/Market/Process/Device/Circuit/
System/IC/Package/PCB/Application*
- The Means: *Technology Leaps* → *Robust, Low V, Low I_{in} , High I_{out} , High Perf.*
Mixed-Signal ICs → *Integration* of *Power Passives* and
Alternate Energy Storage and *Sourcing Devices* (*Li-Ion
Batteries, fuel cells, etc.*)...
- The Goal: *Portable, Self-Powered, Self-Sustaining, SiP/SoC/SoP
Solutions*

- End -